



SEMIPACK® 1

## Thyristor Modules

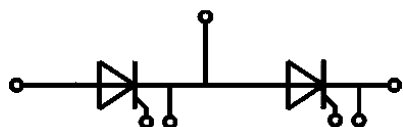
## SKKT 140/16 E

## Features\*

- Heat transfer through aluminium oxide ceramic insulated metal baseplate
- UL recognized, file no. E63532

## Typical Applications

- Fully controlled rectifiers
- AC motor soft starters
- AC power regulation
- AC switch



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## Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
Chip				
I <sub>T(AV)</sub>	sin. 180°	T <sub>c</sub> = 85 °C	145	A
	T <sub>j</sub> = 130 °C	T <sub>c</sub> = 100 °C	110	A
I <sub>TSM</sub>	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	2600	A
		T <sub>j</sub> = 130 °C	2210	A
i <sup>2</sup> t	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	33800	A <sup>2</sup> s
		T <sub>j</sub> = 130 °C	24421	A <sup>2</sup> s
V <sub>RSM</sub>	T <sub>j</sub> = 25 °C		1700	V
V <sub>RRM</sub>	T <sub>j</sub> = 25 °C		1600	V
V <sub>DRM</sub>	T <sub>j</sub> = 25 °C		1600	V
(di/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C		200	A/μs
(dv/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C		1000	V/μs
T <sub>j</sub>			-40 ... 130	°C
Module				
T <sub>stg</sub>			-40 ... 125	°C
V <sub>isol</sub>	a.c.; 50 Hz; r.m.s.	1 min	3000	V
		1 s	3600	V

## Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
<b>Chip</b>					
$V_T$	$T_j = 25\text{ °C}$ , $I_T = 420\text{ A}$			1.85	V
$V_{T(TO)}$	$T_j = 130\text{ °C}$			0.90	V
$r_T$	$T_j = 130\text{ °C}$			2.6	mΩ
$I_{DD}; I_{RD}$	$T_j = 130\text{ °C}$ , $V_{DD} = V_{DRM}$ ; $V_{RD} = V_{RRM}$			20	mA
$t_{gd}$	$I_G = 1\text{ A}$		$T_j = 25\text{ °C}$	1	μs
$t_{gr}$	$di_G/dt = 1\text{ A/μs}$		$T_j = 25\text{ °C}$	2	μs
	$V_D = 0.67 \cdot V_{DRM}$				
$t_q$	$T_j = 130\text{ °C}$		200		μs
$I_H$	$T_j = 25\text{ °C}$			220	mA
$I_L$	$T_j = 25\text{ °C}$ , $R_G = 33\text{ Ω}$			550	mA
$V_{GT}$	$T_j = 25\text{ °C}$ , d.c.	2.5			V
$I_{GT}$	$T_j = 25\text{ °C}$ , d.c.	100			mA
$V_{GD}$	$T_j = 130\text{ °C}$ , d.c.			0.25	V
$I_{GD}$	$T_j = 130\text{ °C}$ , d.c.			4	mA
$R_{th(j-c)}$	cont.		per chip	0.13	K/W
			per module	0.065	K/W
$R_{th(j-c)}$	sin. 180°		per chip	0.17	K/W
			per module	0.085	K/W
$R_{th(j-c)}$	rec. 120°		per chip	0.18	K/W
			per module	0.09	K/W
<b>Module</b>					
$R_{th(c-s)}$	chip, P12 (reference)		0.09		K/W
	module, P12 (reference)		0.05		K/W
$M_s$	to heatsink M5	4.25		5.75	Nm
$M_t$	to terminals M5	2.55		3.45	Nm
a				5 * 9.81	m/s <sup>2</sup>
w			75		g

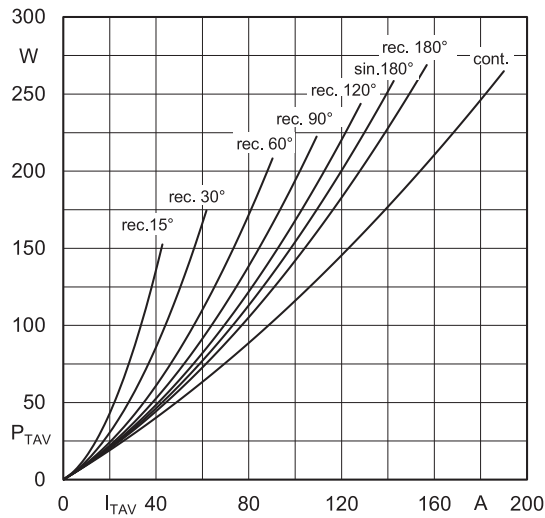


Fig. 1L: Max. power dissipation per chip vs. on-state current

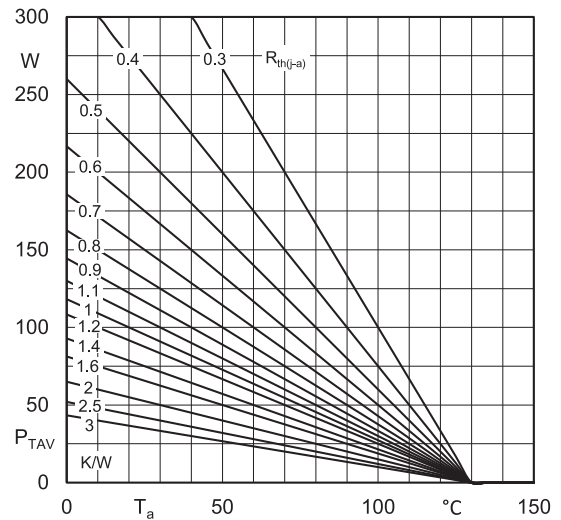


Fig. 1R: Max. power dissipation per chip vs. ambient temperature

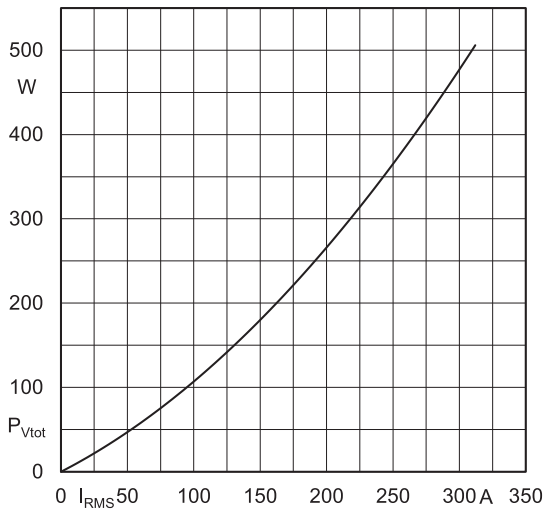


Fig. 2L: Max. power dissipation of one module vs. rms current

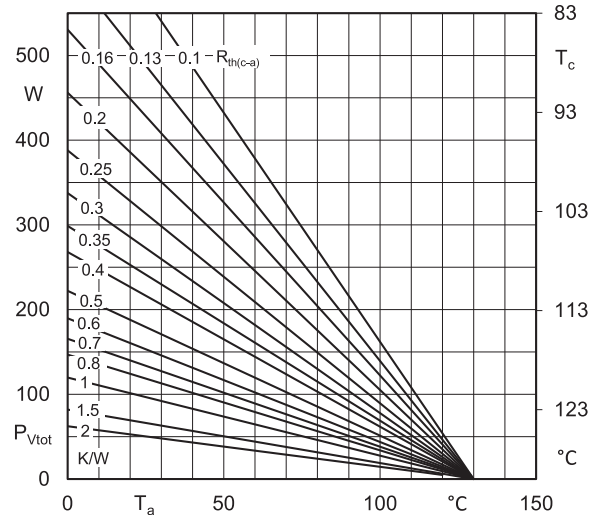


Fig. 2R: Max. power dissipation of one module vs. ambient temperature

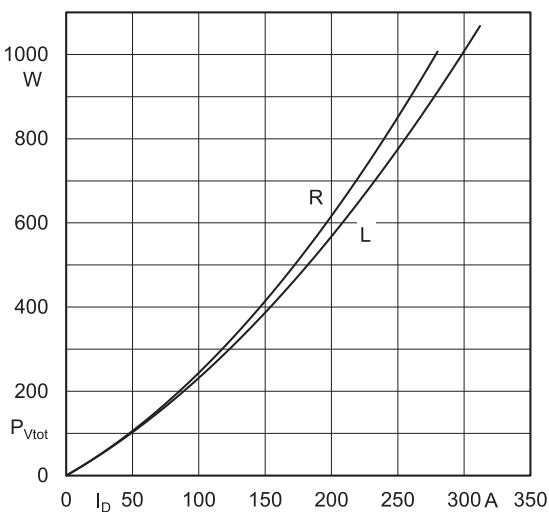


Fig. 3L: Max. power dissipation of two modules vs. direct current

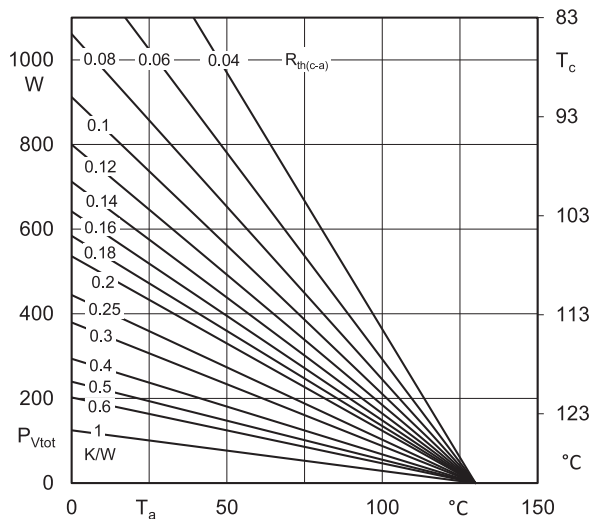


Fig. 3R: Max. power dissipation of two modules vs. ambient temperature

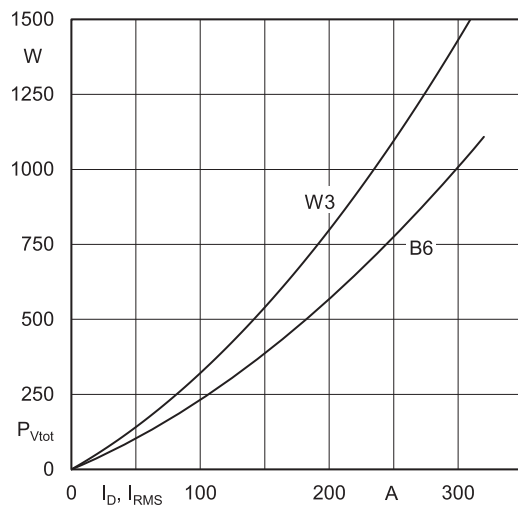


Fig. 4L: Max. power dissipation of three modules vs. direct current

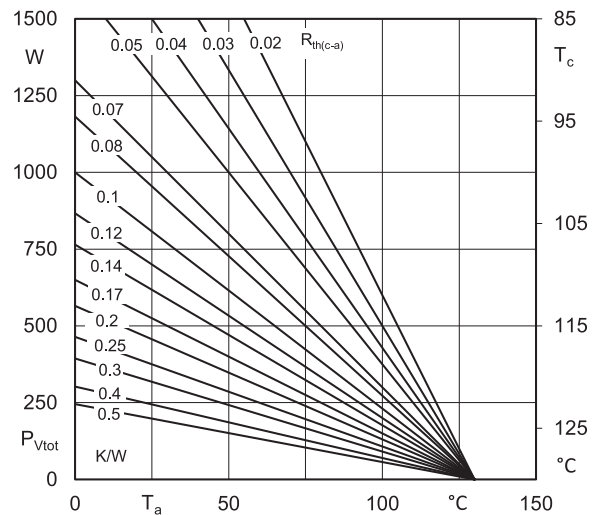


Fig. 4R: Max. power dissipation of three modules vs. ambient temperature

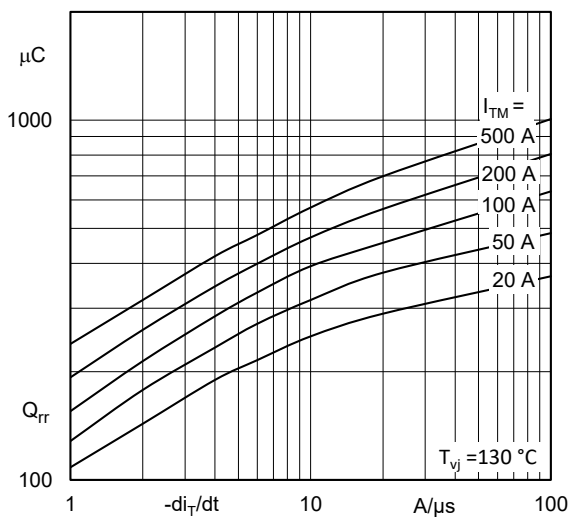


Fig. 5: Recovered charge vs. current decrease

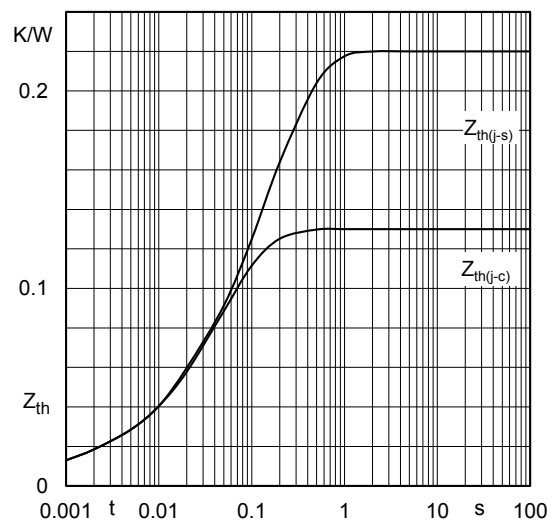


Fig. 6: Transient thermal impedance vs. time

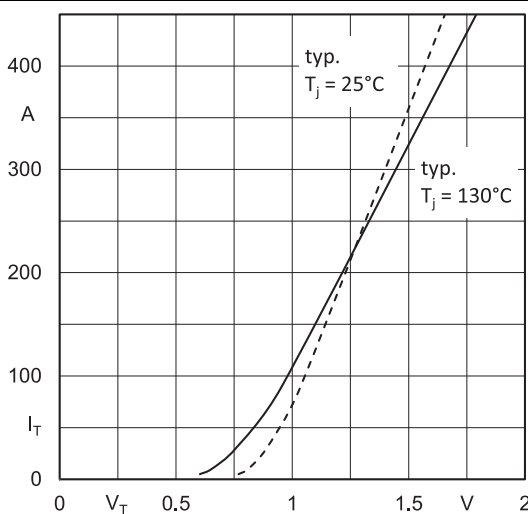


Fig. 7: On-state characteristics

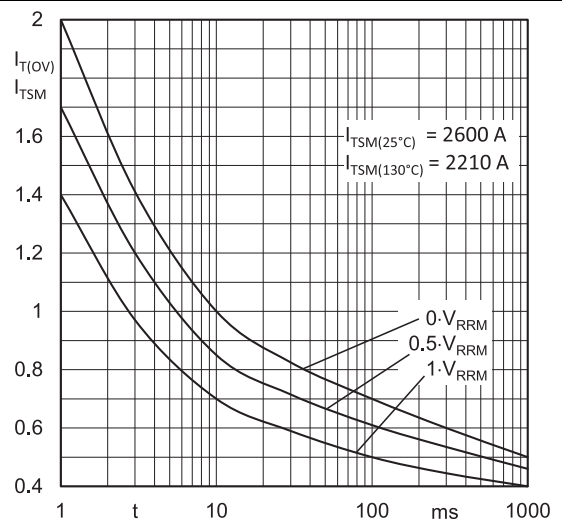


Fig. 8: Surge overload current vs. time

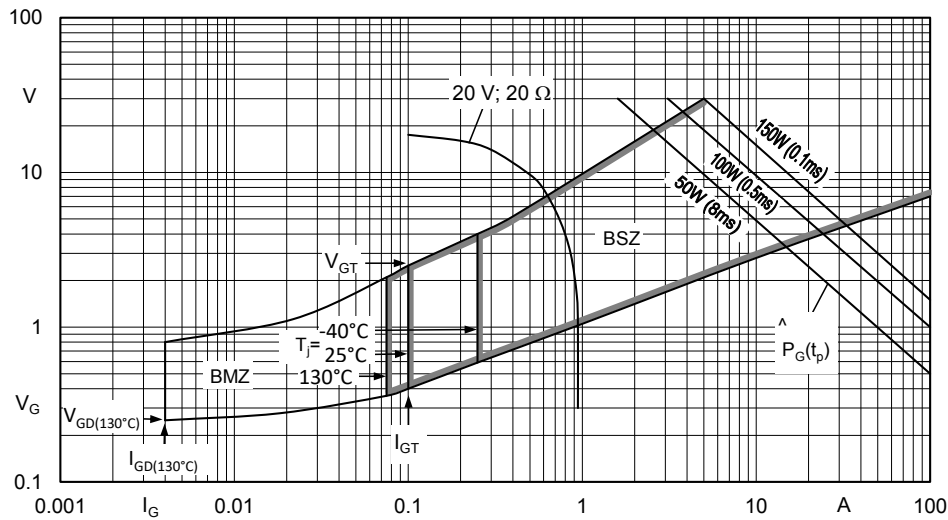
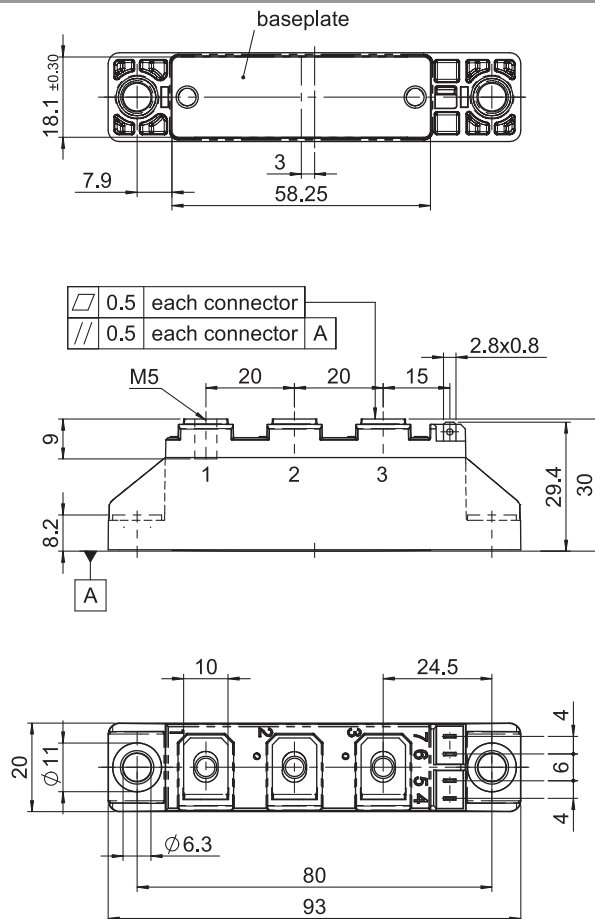
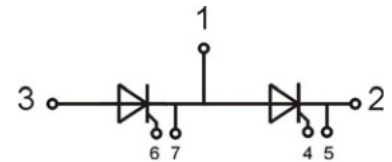


Fig. 9: Gate trigger characteristics



general tolerance  $\pm 0.5\text{mm}$

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## IMPORTANT INFORMATION AND WARNINGS

This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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